Massive Ag migration through metal/ceramic nano-multilayers: an interplay between temperature, stress-relaxation and oxygen-enhanced mass transport†

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The phase stability and microstructural evolution of nano-multilayer (NML) coatings during thermal treatments have attracted increasing attention in several technological fields, such as plasmonics, optics and joining. In the present study, the microstructural evolution of (Ag/AlN)5/10 nm NML coating upon heating in air and under vacuum was investigated by a combinatorial approach using SEM, TEM, XPS and XRD (both in the laboratory and at the synchrotron facility). Fast heating of the Ag/AlN NML in air up to 420 °C leads to an extensive migration of nano-confined Ag to the NML surface at temperatures as low as 200 °C, much below the Ag bulk melting point. Remarkably, the migration of Ag towards the surface is negligible for a similar heat treatment under vacuum, as well as for a thick Ag layer (i.e. in the absence of a nano-confinement of Ag). Outward migration of Ag is driven by the reduction of internal interfaces (i.e. nanograin- and phase-boundaries) in combination with the relaxation of thermally induced compressive stresses. The enhanced mobility of Ag in an O-rich atmosphere is attributed to the reduction of the activation energies for vacancy diffusion through Ag/AlN multilayers by controlled laser annealing (i.e. nano-confinement of Ag). The combined effects of nano-confinement, thermal stresses and an O-rich atmosphere in the Ag/AlN NML may be exploited for novel low-temperature joining applications.

1. Introduction

Nanoscale devices promise substantial technological advancements in numerous fields, such as in electronics, catalysis, optics, energy storage and medicine.1–4 Nowadays, several different approaches are routinely used to produce nanomaterials, including sol-gel techniques, supersonic cluster beam depositions, pyrolysis, milling processes, and chemical- and physical-vapor deposition (CVD/PVD).5–9 Over the past few decades, layer-by-layer assembly of thin films by PVD has been vastly exploited, because it enables low-cost fabrication of functional nanostructures with tunable properties in a wide range of substrate materials.10,11 Nano-multilayer (NML) configurations, in which alternating layers of different materials are stacked with a given periodicity, are among the most common nano-architectures fabricated by PVD. The high density of hetero-interfaces in such NMLs imposes dimensional and microstructural constraints to the mobility of atoms, defects, electrons, photons, phonons and plasmons, which results in unusual electronic, optical, magnetic and mechanical properties.12–15 Evidently, the functional properties of NML structures strongly depend on the bilayer periodicity, individual layer thicknesses and, in particular, on the (defect) structure of the internal interface.16 Hence, novel functional devices based on NML architectures can be designed by controlling size effects and by interface engineering.

Recently, metal/ceramic NMLs have attracted huge interest in various application areas, such as those related to plasmonic devices,17,18 nano-joining technologies19–21 and optical coatings.22 The applicability of these emerging NML-based technologies critically depends on the thermal, chemical and mechanical stability of the NML structure during fabrication, processing and subsequent operation, which may involve thermal treatments, exposure to reactive gases or liquids and/or thermo-mechanical loadings. For example, Siozios et al. reported one of the first studies on Ag diffusion through Ag/AlN multilayers by controlled laser annealing in air, which resulted in a homogeneous dispersion of Ag nanoparticles throughout the AlN layers.18,23 The size and distribution of the Ag nanoparticles were found to strongly depend on the
microstructure of the as-deposited Ag/AlN layers and hence on the deposition conditions.\textsuperscript{17} Moreover, it was observed that slower thermal annealing in air results in the outward diffusion and self-organization of Ag in small nanoparticles at the surface, whereas faster local heating by laser annealing induces local crystallization of the AlN matrix (as associated with an enhancement and a shift of the surface plasmon resonance).\textsuperscript{24} On the basis of these experimental findings, the effects of the deposition parameters and laser treatment (i.e. number of laser pulses, wavelength, fluence) on the microstructural evolution of Ag/AlN NMLs were elucidated.\textsuperscript{25}

Only very recently, Ag/AlN, Cu/AlN and Ag–Cu/AlN NML coatings have also been envisaged as low-temperature brazing nano-fillers for packaging and assembling miniaturized devices and heat-sensitive components at ever-reduced processing temperatures.\textsuperscript{20,21,26} Such NML brazing fillers are typically composed of alternating nanolayers (individual thickness \(\leq 10\) nm) of a metal (or alloy) and a chemically-inert barrier (e.g. oxides, nitrides or refractory metals). Using NML coatings, the brazing temperature can be lowered by exploiting the effects of a size-dependent melting point depression of the confined metal and the intrinsically high atomic mobility along internal interfaces (e.g. incoherent phase interfaces and high-angle grain boundaries).\textsuperscript{27} Alternatively, nanoparticle pastes constituting a noble-metal (e.g. Ag or Au)\textsuperscript{28} are considered as promising candidates for low-temperature joining applications. However, health and safety issues related to the handling of nano-particle pastes still limit their potential use on a large scale. With this regard, low-temperature joining using NML coatings could be a real technological breakthrough, provided that the directional migration (outflow) of the confined metal filler can be triggered and exploited for chemical bonding at low temperatures, forming a solid joint.\textsuperscript{19–21}

Still, to the best of our knowledge, comprehensive investigations of the driving forces and underlying mechanisms which govern the phase stability and atomic mobility of confined metals in NMLs during heating have not been reported yet. The current work presents a comprehensive experimental investigation of the microstructural evolution of Ag/AlN NML coatings upon heating in air and under UHV by application of a combinatorial analytical approach using scanning electron microscopy (SEM), transmission electron microscopy (TEM), X-ray spectroscopy (XPS) and X-ray diffraction (XRD). The experimental findings indicate that both the processing atmosphere and the stress state play a fundamental role in determining the thermal evolution of the system. These combined effects could be exploited to activate and direct the migration of Ag to the NML surface, allowing chemical bonding at strikingly low temperatures. The underlying mechanisms for this low-temperature process are disclosed and discussed.

2. Experimental

2.1 Sample preparation

Ag/AlN NMLs were deposited on 2\textsuperscript{″} epi-polished \(\alpha\)-Al\(_2\)O\(_3\)\(\{1\bar{1}02\}\) single-crystalline wafer substrates (i.e. sapphire-R wafers) by magnetron sputtering in a high vacuum chamber (base pressure \(\leq 1 \times 10^{-8}\) mbar) from two confocally arranged unbalanced magnetrons equipped with 2\textsuperscript{″} targets of pure Ag (99.99\%) and Al (99.99\%). Before insertion in the deposition apparatus, the sapphire substrates were ultrasonically cleaned in acetone and isopropanol. Prior to deposition, possible surface contamination on the \(\alpha\)-Al\(_2\)O\(_3\)\(\{1\bar{1}02\}\) substrate (mostly adventitious C) was removed by Ar\textsuperscript{+} sputter cleaning for 5 min by applying a RF Bias of 100 V. In the first deposition step, a 10 nm thick AlN layer was deposited on the substrate. Next, 20 repetitions of a bilayer unit consisting a 5 nm thick Ag layer and a 10 nm thick AlN barrier layer were deposited on top (Scheme 1).

2.2 Measurements

The phase constitution, texture and morphology of the as-deposited and thermally treated NMLs were analyzed by SEM, TEM, XRD and XPS. In addition, \textit{in situ} high-temperature XRD (HT-XRD) analysis upon heating was carried out at the Swiss Light Source (SLS) synchrotron facility (PSI Villigen, Switzerland).

\textbf{Electron microscopy.} High-resolution SEM imaging of the samples was performed in plain view using a Hitachi S-4800 device equipped with a Bruker XFlash 6|60 energy dispersive X-ray (EDX) detector. In order to be surface sensitive, the SEM investigations (imaging and EDX-measurements) were performed at 5 kV, which is high enough to excite the adsorption edge of both constituting elements (M-lines of W, L-line of Cu). The TEM observations have been performed using a Hitachi STEM HD2700 scanning-transmission electron microscope with an accelerating voltage of 200 kV. The TEM specimens were cut as cross-sections of the deposited layers using an NBS0000 dual beam system (Hitachi High Technologies Corporation, Japan) with Ga\textsuperscript{+} ion beam. In order to reduce the lamella thickness, low energy ion polishing has been employed. A GentleMill (Technoorg Linda Ltd, Hungary) device with Ar\textsuperscript{+} ion beam operated at an accelerating voltage below 1 kV has been used.

\textbf{Standard and real-time X-ray diffraction.} A Discover (D8) X-Ray Diffractometer from Bruker, operating in Bragg-Brentano geometry, was applied to measure theta-2-theta (2\theta) scans. In addition, texture measurements (i.e. pole figures) of the Ag(111) and AlN(103) reflections were recorded before and after heating up to 420 °C in air. The XRD data were collected in the 2\theta range of 20–100° with a step size of 0.02° using Cu K\(_{\alpha1,2}\) radiation (\(\lambda_{\text{average}} = 0.15418\) nm, 40 kV and 40 mA).

Scheme 1 Structure of the as-deposited (Ag/AlN)\(_{10\text{nm}}\)10\text{nm}, NML coating.
The microstructural evolution of the NMLs was \textit{in situ} monitored from room-temperature (RT) to 420 °C by real-time synchrotron XRD in the Material Science beamline (X03MA) at the SLS. The X03MA beamline is conceived to provide X-rays in the energy range of 5–40 keV for diffraction experiments. The experiments were carried out on the powder diffraction branch using a photon energy of 20 keV ($\lambda = 0.61986 \text{ Å}$) and a MYTHEN single-photon-counting silicon micro-trip detector, which allowed the acquisition of the diffraction patterns over $120^\circ$ in 2theta in less than 40 s. Hence, at least one 2theta spectrum was recorded every 10 °C during fast heating at a rate of up to 20 °C min$^{-1}$ (a detailed description of the beamline setup and the detector is given elsewhere$^{28,29}$). The beamline setup was equipped with a custom-designed furnace for \textit{in situ} heating (HTK 16 MSW), especially constructed for transmission diffraction measurements at ambient pressure in air. The applied temperature ramp during \textit{in situ} heating and simultaneous XRD analysis is shown in Fig. 1. First, the specimen was pre-heated up to 160 °C and thermally equilibrated for roughly 15 min. Next, the specimen was heated up to 320 °C at an nearly constant rate of 4.6 °C min$^{-1}$ and subsequently up to 420 °C at maximum power (of the ceramic heating plate) resulting in a heating rate of 20 °C min$^{-1}$. The specimen was kept at 420 °C for 40 min, after which the heat source was switched off, allowing the sample to freely cool down to room temperature.

**X-ray spectroscopy.** X-ray Photoelectron Spectroscopy (XPS) analysis was performed \textit{ex situ} on both as-deposited and heat-treated Ag/AlN NML samples using a Physical Electronics (PHI) Quantum 2000 setup (base pressure < $1 \times 10^{-9}$ mbar), equipped with a monochromatic Al Kα anode (1486.68 eV and spot size of 100 μm) and a hemispherical electron-energy analyzer. Energy calibration was carried out before and after each set of measurements by referencing the energy scale to the Au 4f$^7$/2 core level peak positioned at 84.0 eV, as measured from a sputter-cleaned Au reference sample. Composition–depth profiles were recorded by employing alternating cycles of sputtering and XPS analysis using a focused 1 kV Ar$^+$ ion beam rasterizing an area of $(1 \times 1)$ mm$^2$ at an incident angle of 45°. During each successive analysis step, the Ag 3d, Al 2p, Al 2s, N 1s, O 1s and C 1s core level spectra were recorded. Spectral reconstruction was performed by employing the linear least-squares fitting procedure of the PHI Multipack software (version 8.2). For the quantification of the thus-resolved peak intensities (areas), the relative elemental sensitivity factors supplied by the system manufacturer were employed. With this setup, an accuracy of ~5% can be routinely achieved. Carbon was only detected at the outer surface (i.e. first 1–2 nm) and was therefore not considered in the quantitative XPS analysis.

3. Results and discussion

3.1 NML morphology

The Ag/AlN NMLs, as deposited on α-Al$_2$O$_3$(1102) substrates by magnetron sputtering, are constituted of a 10 nm thick AlN bottom layer and 20 repetitions of a unit comprising a 5 nm thick Ag layer and a 10 nm thick AlN barrier layer. SEM micrographs of the surface of the Ag/AlN NML in the as-deposited state and after heat treatment up to 420 °C in air are shown in Fig. 1a and b, respectively. Corresponding cross-sectional TEM micrographs are presented in Fig. 1c and d. It follows that the alternating Ag and AlN layers are well resolved for the as-deposited state. Notably the first as-deposited layers have a rather uniform thickness whereas successive ones progressively roughen towards the NML surface (Fig. 1c). The progressively enhanced layer roughness originates from the poor wetting of Ag on AlN, which hinders the formation of laterally closed Ag layers during successive deposition steps (by impingement and coalescence of nucleated Ag islands). Nonetheless, the NML surface still appears rather homogeneous on a large scale, with only some step-like corrugations due to the aforementioned island-by-layer 3D growth mode (see the inset of Fig. 1a).

Fast annealing in air up to 420 °C causes pronounced changes in the NML structure. In particular, a high density of homogeneously distributed Ag particles arises at the surface after heating (Fig. 1b and 2). These Ag particles are preferentially round-shaped, with a lateral size spanning between tenths of nanometers and about 1 μm. The cross-sectional TEM analysis of the heat-treated NML no longer displays a distinct contrast between successive layers (Fig. 1d), in accordance with an extensive migration of the confined Ag during heating in air (i.e. leaving only a minor amount of metallic filler inside the layered structure).

It is concluded that heating the Ag/AlN NML in air to 420 °C results in an extensive migration of the Ag filler to the outer NML surface at temperatures well below the bulk melting point of Ag ($T_m = 962 °C$). Strikingly, the Ag surface coverage is much less after an identical heat treatment carried out in an oxygen-deficient atmosphere (UHV) or on a bulk-like Ag layer (i.e. without a nano-confinement of the Ag metal; see ESI,† Fig. S1). In the latter cases, the few Ag particles found on the surface appear remarkably smaller in size and/or number and occasionally nanowires are formed instead of spherical-shaped protrusions. Importantly, in the absence of a nano-confinement of the Ag, as for a thick Ag layer (200 nm) sandwiched between two AlN barriers, nearly no metal relocate on the surface after annealing in air (see ESI,† Fig. S1b).

These experimental findings suggest that the thermally activated mass transport of Ag from the NML interior to the outer surface is promoted and driven by the combined effects of nano-confinement and an O-rich processing atmosphere. To disclose the underlying mechanism(s) for Ag migration, a detailed microstructural analysis of the as-deposited and heat-treated Ag/AlN NMLs was performed by applying a combinatorial analytical approach using \textit{ex situ} XRD (using laboratory setups), \textit{in situ} real-time transmission XRD (at the synchrotron facility) and \textit{ex situ} XPS analysis (both chemical state analysis and sputter-depth profiling), as discussed in the following.

3.2 Microstructure and texture

Fig. 3a shows the diffractograms of the as-deposited and heat-treated Ag/AlN NMLs, as measured \textit{ex situ} in Bragg–Brentano geometry. For the as-deposited state (black spectrum), the most intense reflections appear as typical superlattice (multi) peaks due to the periodic NML structure. This superlattice structure is
found in the $2\theta = 32^\circ$–$42^\circ$ region, indicating preferred Ag[111] and AlN[001] growth directions during sputter deposition. This is expected, since the Ag[111] and AlN[001] planes constitute the most densely packed planes of lowest surface energy. Additional Ag(200) and Ag(220) reflections with much lower intensities and broad profiles are detected at $2\theta \approx 44^\circ$ and $\sim 65^\circ$, respectively. This indicates that the as-deposited Ag/AlN NML is not an ideal stacking of single-oriented Ag planes, but also contains a (small) fraction of randomly oriented crystallites.

The superlattice (multi) peaks arise from the periodic NML structure. This region of the diffractogram was theoretically calculated on the basis of a kinematic formalism which included Ag[111] and AlN[001] textures with interface disorder. The observed satellite peaks are well reproduced within the model, allowing an estimation of the Ag/AlN bilayer unit thickness of 13.5 nm, in good agreement with the nominal value of 15 nm (for a detailed description of this computation, see ESI† Fig. S2). The aforementioned Ag[111] and AlN[001] preferred growth directions were also confirmed by pole figure measurements of Ag{111} and AlN{103}: see Fig. 3b and c. Both the Ag{111} and AlN{103} pole figures exhibit a six-fold symmetry, which indicates the existence of an epitaxial relationship between the alternating Ag and AlN layers (i.e. both in-plane and out-of-plane texture). In the Ag[111] pole figure (Fig. 3b), the angle between the central pole and the secondary ones is $\Psi \sim 70.5^\circ$, which matches the expected angle between equivalent planes belonging to Ag[111]. In the AlN{103} pole figure (Fig. 3c), the angle between the central pole and the secondary poles is $\Psi \sim 31^\circ$ (indicated by a dashed white ring), corresponding to the angle between the AlN{001} and AlN{103} directions. It follows that the alternating Ag and AlN layers obey an epitaxial orientation relationship according to Ag[111]||AlN[001]||AlN[103], as also reported in ref. 19.
After heat treatment in air up to 420 °C, the Ag(111), Ag(200) and Ag(220) reflections in the measured theta-2theta (t2t) scans significantly increase in intensity and approximately match the expected reciprocal ratios for bulk polycrystalline Ag (red spectrum in Fig. 3a). Still the Ag/AlN superlattice modulation is partially maintained, suggesting that the nano-laminated structure is to some extent preserved after the heat treatment, in accordance with the cross-sectional TEM analysis (Fig. 1). Moreover, Ag{111} pole figure measurements show an overall decrease of the six-fold Ag{111} intensity poles (see Fig. 3b), indicating a partial loss of in- and out-of-plane texture of Ag upon heating. This implies that the Ag particles that are formed at the NML surface during heating (by extensive outward migration; cf. Fig. 1) adopt a more random orientation as compared to the highly textured Ag nanocrystals inside the NML. The increased contribution of randomly oriented Ag crystals to the diffracted intensity also results in a substantial increase of the background intensity in the Ag{111} pole figure after heating (Fig. 3b). The corresponding texture measurements for the AlN{103} family of planes also indicate a partial loss of the primary AlN{001} texture after heating. Interestingly, the measured t2t scan of the heat-treated NML (Fig. 3a) does not exhibit distinct changes of the Ag diffraction pattern after annealing up to 420 °C: besides superlattice peaks, no additional AlN reflections arise after heating. This may indicate the formation of an amorphous reaction product within the AlN barrier layers upon heating, as will be discussed in more detail below.

3.3 Stress evolution during heating by real-time transmission-XRD

The microstructural evolution of the Ag/AlN NML during annealing in air up to 420 °C and subsequent cooling was monitored by real-time XRD collected in the transmission mode using synchrotron radiation (λ = 0.61986 Å and hv = 20 keV). The corresponding real-time XRD map during heating is shown in Fig. 4, as constructed by stacking the measured 2theta scans as a function of time. The corresponding temperature ramp followed during the treatment is presented in the right panel of Fig. 4. Fig. 5 shows the changes of the Full Width Half Maximum (FWHM) of Ag(222) and AlN(100) diffraction peaks, respectively. Moreover, the size of the coherently diffracting domains (coherence length) for Ag and AlN is also reported (as estimated on the basis of the Scherrer formula; see below).

As follows from Fig. 4, only the Ag(111), Ag(311) and Ag(222) reflections are detected in the as-deposited sample, as attributed to the primary texture of the confined Ag layers (cf. Fig. 3b). Up to 250 °C, the recorded diffractograms show no significant changes and the resolved FWHMs and the estimated coherence length of Ag grains are approximately constant (Fig. 5). The initial coherence length of Ag domains of ~6 nm from room temperature (RT) up to 250 °C, as well as the nearly constant coherence length of AlN domains of ~9 nm from RT up to 420 °C, is approximately equivalent to the Ag and AlN layer thicknesses in the as-deposited state. Strikingly, as soon as the temperature reaches ~250 °C, all the reflections associated with polycrystalline Ag gradually appear, which is accompanied by (i) a strong increase of the Ag(222) FWHM and (ii) a strong increase of the average Ag domain size from ~6 nm at RT to 160 nm at 420 °C (Fig. 4 and 5). The decrease of the Ag(222) FWHM (and the corresponding simultaneous increase of the Ag domain size) suggests a domain coarsening by Ag grain-growth. Noteworthily, the decrease of the AlN(100) FWHM and simultaneous increase of the AlN domain size from RT to 420 °C is much less pronounced; that is, the FWHM decreases from 0.33° to 0.29° corresponding to a relatively small increase of the average domain size from ~9 nm to ~12 nm, respectively; see Fig. 5. Thus, these experimental findings evidence the migration of the confined Ag atoms to the NML surface at a temperature as low as 250 °C. Indeed, as confirmed by the SEM analysis (Fig. 1b), a large density of metallic Ag particles is present on the surface after heating up to 420 °C. The Ag particles can coarsen at a much higher rate at the free surface as compared to the (remaining) confined Ag nano-grains within the NML.
As follows from recent thermodynamic predictions of the phase stability of nano-confined layered metals, the reduction of internal boundaries or, more specifically, the reduction of the sum of grain-boundary, interface and surface (excess) energies to the total Gibbs energy of the system, provides the dominant driving force for the migration from a NML interior to the free surface upon heating. In our work, as evidenced from the microscopic and XRD analysis (see Fig. 1–5), the migration of Ag towards the surface becomes thermally activated at around 200 °C, but again decelerates at around 400 °C. This suggests that besides the reduction of the sum of grain-boundary, interface and surface energies, an additional mechanism for Ag outward migration is active in the temperature range 200 °C to 400 °C, which ceases at temperatures T > 400 °C. Considering the large differences in thermal expansion coefficients between the Al2O3 substrate and the Ag and AlN layers, the accumulation and subsequent relaxation of thermally-induced stress gradients in the NML upon heating could promote directional Ag migration. Namely the relaxation of thermal stresses can be easily achieved at the free surface, but not at the interface. Indeed directional (inward) migration of Ag to the NML/substrate has not been observed in the present study.

To investigate the stress evolution of the NML during heating and subsequent cooling, the Ag(111) and Ag(222) diffraction peaks in the real-time XRD data set were analyzed using the Uniform Stress Deformation Model (USDM) as described in more details in the ESI.† In addition, the measured changes of the Ag{222} and AlN{100} lattice spacings are reported as a function of temperature.

Although the USDM method for stress evaluation is rather crude, distinct changes in the residual stress state of Ag can be observed in the temperature range from 170 °C to 400 °C, see Fig. 6. In the as-deposited state, the confined Ag layers have an average compressive residual stress of about 100 MPa. The initial compressive stress state of the confined Ag layers mainly originates from accumulated growth stresses during the sputter deposition.
deposition process and interface stresses due to the lattice mismatch between AlN and Ag. Since the thermal expansion of bulk (unstrained) silver ($\sigma_{Ag} \approx 19$ °C$^{-1}$)$^{14}$ is significantly larger than that of the $\alpha$-Al$_2$O$_3$ substrate ($\sigma_{sapphire} \approx 8$ °C$^{-1}$)$^{15}$ additional compressive stresses should be generated in the confined Ag upon heating. However, during the first stage of heating up to about 200 °C, the compressive stress state of the confined Ag remains relatively constant (Fig. 6), which suggests that compressive stress generation by the thermal expansion mismatch is probably counteracted by tensile stress generation due to the annihilation of growth defects (and possibly also by the annihilation of grain boundaries due to domain coarsening$^{20,36}$).

The expected accumulation of compressive stresses in the confined Ag layers (due to the thermal expansion mismatch) proceeds in the temperature range of 200 °C $< T < 280$ °C. The accumulated compressive stresses reach a maximum value of $\sigma = -650$ MPa at 280 °C. However, the accumulated stresses become fully relaxed upon further heating in the range 280 °C $< T < 400$ °C, which runs parallel with the observed migration of the confined Ag to the NML surface (Fig. 1). At $T > 400$ °C, as well as during subsequent cooling, the Ag metal maintains an essentially stress-free state (reaching a final stress of around $-80$ MPa after cooling down to RT). This is not surprising, since during heating up to 420 °C, a large amount of Ag is relocated as particles on the NML surface (cf. Fig. 1), which can nearly freely contract in a bulk-like manner during subsequent cooling (without being affected by the NML confinement and/or the thermal shrinkage of the $\alpha$-Al$_2$O$_3$ substrate). Indeed the linear thermo-elastic slope of the Ag(222) d-spacing during cooling complies well with the linear thermal expansion coefficient of bulk, unstrained Ag (Fig. 7a).

It may be assumed that the creation of free volume and pores within the NML by Ag outward migration (as experimentally observed for heat-treated AgCu/AlN NMLs$^{37}$) aids the relaxation of residual stresses in the AlN barrier layers. Indeed, during the first stage of heating up to 250 °C, the AlN(100) d-spacing increases approximately linearly with a thermal expansion of $\sigma_{AlN} = 9.7$ °C$^{-1}$, which is much larger than that of bulk (unstrained) AlN (5 °C$^{-1}$)$^{38}$ but close to that of bulk $\alpha$-Al$_2$O$_3$ (8 °C$^{-1}$): see Fig. 7b. For $T > 250$ °C, the linear thermal expansion becomes much lower (i.e. $\sigma_{AlN} = 3.3$ °C$^{-1}$), indicating a (partial) relaxation of thermal stresses in the AlN barrier layers during Ag outward migration. Isothermal annealing at 420 °C results in a further decrease of the AlN(100) spacing towards the reference value of 2.698 Å for unstrained bulk AlN at 420 °C, indicating a stress-free state of the AlN. The AlN barrier layers still adhere to the (infinitely thicker) $\alpha$-Al$_2$O$_3$ substrate upon heating up to 420 °C. Consequently, the shrinkage of the AlN barrier layers during cooling is dictated by the $\alpha$-Al$_2$O$_3$ substrate (i.e. the linear thermal expansion of AlN during cooling follows that of the $\alpha$-Al$_2$O$_3$ substrate: $\sigma_{AlN} = 7.8$ °C$^{-1}$ versus $\sigma_{sapphire} \approx 8$ °C$^{-1}$): see Fig. 7b.

Although compressive stress relaxation by Ag outflow ceases at $T \approx 400$ °C, the Ag(222) FWHM still continues to decrease upon further heating, which indicates further coarsening of Ag surface particles during isothermal annealing. This supports our previous statement (see also ref. 27) that the reduction of the sum of grain-boundary, interface and surface energies provides the
main driving force for Ag migration and grain coarsening up to 420 °C. Thus, it is concluded that compressive stress relaxation is active as an (additional) driving force for Ag outward migration in the temperature range of 280 °C < T < 400 °C.

3.4 Chemical driving force: the role of oxygen in Ag/AlN thermal evolution

The main driving forces and underlying mechanisms for the outward migration of confined Ag at temperatures as low as 200 °C have been elucidated above. However, it still remains unclear why the Ag mobility is hugely enhanced upon heating in air as compared to heating under UHV (cf. ESI† Fig. S1). To identify the prominent role of oxygen in enhancing the mobility of Ag at such low temperatures, an extensive chemical state investigation by XPS was conducted as follows.

Fig. 8a shows a composition–depth profile of the as-deposited Ag/AlN NML, as obtained by XPS sputter-depth profiling. The laminated structure of the Ag/AlN NML in the as-deposited state results in regular oscillations of the measured atomic concentrations of Ag, Al and N as a function of depth. The characteristic damping of the oscillating Ag, Al and N concentrations with increasing sputter depth (Fig. 8a) is generally attributed to the following superimposed sputter-induced artifacts: (i) an enhanced degree of intermixing with increasing sputter depth, (ii) an increase of sputter-induced roughness with increasing sputter depth and (iii) the preferential sputtering of Ag (due to the much lower surface binding energy of Ag as compared to that of AlN; i.e. Eₜ = 3.1 eV versus Eₜ = 9.1 eV, respectively). Due to these superimposed sputter artifacts, the measured atomic concentration of Ag within the successive Ag layers progressively decreases with increasing sputter depth towards a steady-state Ag concentration of 20 at% (Fig. 8a). The XPS analysis confirms that the NML is composed of pure Ag metal and pure AlN with minor surface contaminations of O and adventitious C. After the first few sputter cycles, the O 1s and C 1s signal intensities drop below the detection limit, indicating that the O and C contaminations originate from air exposure after the sample removal from the high-vacuum sputter-deposition chamber. The measured XPS spectra of the Ag 3d, Al 2p and N 1s core-level regions after 80 minutes of Ar⁺ sputtering are shown in Fig. 8b–d. The measured Ag 3d XPS in Fig. 8b shows the 5/2–3/2 spin–orbit doublet with a splitting of 6 eV (i.e. 374.3–368.3 eV) and a strong plasmon loss at a binding energy (BE) of around 372.2 eV, which are typical of pure Ag metal (further designated as Ag̅). In the as-deposited state, no additional components at the lower-BE side of the Ag 3d main peak, indicative of Ag₂O or AgO chemical species, were detected. Both the Al 2p and N 1s spectra also constitute a single main peak centered at 74.3 eV and 397.3 eV, respectively, characteristic of O-free AlN.

Bulk AlN is known for its high thermal stability and chemical inertness up to elevated temperatures (about 800 °C, where oxidation advances). However, AlN surfaces are much more reactive toward oxygen and can be easily converted to amorphous Al₂O₃ in air (even at RT) for pristine ceramic thicknesses in the nanometer range. As evidenced from the cross-sectional TEM analysis (Fig. 1), the alternating Ag and AlN layers progressively roughen towards the surface, resulting in a significant number of defects, voids and grain boundaries within the Ag/AlN NML, which may act as defective channels for fast inward diffusion of oxygen species during annealing in air. Hence, annealing of the Ag/AlN NML at ambient pressures probably not only induces oxidation of the top (i.e. surface-adjacent) AlN layer, but also of AlN barrier layers at larger depths below the surface. The composition–depth profiles of the Ag/AlN NML after annealing in air (for 30 min) at 200 °C, 250 °C, 300 °C and 420 °C (as measured by XPS sputter-depth profiling) are presented in Fig. 9a–d. The XPS analysis indeed evidences deep penetration of O inside the NML upon annealing in air. The O surface concentration is in the range of 10–20 at% after the various annealing steps (from 200 to 420 °C). For annealing temperatures of 200 °C, 250 °C, 300 °C, the O concentration rapidly levels off with increasing sputter depth and attains a constant O concentration of about 8 at%, 11 at% and 18 at% in the interior of the NML, respectively (Fig. 9a–c). In contrast, at an annealing temperature of 420 °C, the O concentration increases with increasing sputter depth and attains a much higher concentration of 34 at% within the NML. Strikingly, the concentration of O with increasing sputter depth at 420 °C follows the profiles of Al and N concentrations, which evidences a preferential chemical reaction of O with the AlN barrier layers. The Ag, Al and N oscillations become increasingly damped with increasing annealing temperature (as compared to the as-deposited state) due to the enhanced migration of Ag to the NML surface, which is especially evident in the composition–depth profiles at 300 °C and 420 °C.

**Fig. 8** (a) Composition–depth profile of the as-deposited Ag/AlN NML, as measured by XPS sputter-depth profiling. (b–d) Ag 3d, Al 2p and N 1s core-level spectra, as measured on the as-deposited NML after 55 minutes of Ar⁺ sputtering (displaying the chemical constitution in the interior of the NML).
Next high-resolution XPS measurements were carried out on the heated and sputtered (sputtering time: 80 min) specimens in order to investigate the chemical evolution of the inner part of the NMLs after heating in air. The spectral reconstruction of the measured Al 2p core-level region for different annealing temperatures (Fig. 10a) indicates the appearance of an oxidic Al 2p peak at BE = 75.6 eV due to the formation of an Al-oxide phase.49–51 The oxidic Al 2p intensity increases with increasing annealing temperature. The co-formation of Al–O–N ternary compounds during annealing can be neglected, since it would give rise to an additional Al 2p main peak at BE ≈ 76.2 eV, as well as additional N 1s main peaks at BE ≈ 398.4 eV and/or BE ≈ 402.2 eV,49,52,53 which are not observed. The Al2O3 phase formed from the reaction of O and AlN should be predominantly amorphous, since no oxide-related reflections could be detected in the XRD analysis, in accordance with ref. 43–45.

The spectral reconstructions of the measured O 1s spectra after annealing at different temperatures in air reveal a minimum of three different chemical states of O within the reacted NML (Fig. 10b): i.e. (i) one dominant O 1s peak at BE = 532.3 eV, attributed to Al2O3, which is most evident after annealing at 200–300 °C;49–51 (ii) a second, much weaker O 1s peak at BE = 530.8 eV and (iii) a third O 1s peak at BE = 528.0 eV, which is only observed at the highest annealing temperature of 420 °C. The origin of the weaker O 1s peaks at 530.8 eV and BE = 528.0 eV can be rationalized by considering the reported chemical interaction of O with Ag, as follows. Different chemical species can form on Ag surfaces after O exposure: adsorbed oxygen (Oads), strongly bonded chemisorbed oxygen (Ochem), as well as oxygen incorporated in the subsurface region primarily through fast diffusion paths like grain boundaries (Odis).39,54,55 Oads species are found at RT, while the incorporation of O requires a higher thermal activation and, consequently, is observed towards higher temperatures (usually beyond 200 °C). At even higher temperatures (i.e. T > 500 °C), the Odis species disappear by forming stronger chemically bonded Ochem species at the surface.39,53,56 Unfortunately, the different chemical species

![Fig. 9 XPS composition–depth profiles of the Ag/AlN NML after annealing for 30 minutes at (a) 200 °C, (b) 250 °C, (c) 300 °C and (d) 420 °C.](image)

![Fig. 10 Spectral reconstruction of the (a) Al 2p XPS and (b) O 1s core-level spectra as measured in the interior of the air-annealed NMLs (i.e. after sputtering for 80 min).](image)
(i.e. O_{ads}, O_{chem}, O_{diss}) cannot be resolved from the measured Ag 3d peak, because the respective chemical shifts are too small.\textsuperscript{55,57} However, it has been reported that at least O_{ads} and O_{diss} species can be resolved from the O 1s core-level region at BE ≈ 530.4 eV\textsuperscript{39,55,58} which is close to the BE of the detected O 1s component at BE = 530.8 eV (red peak in Fig. 10b). Noteworthily, the intensity of this weak O 1s component slightly increases with increasing temperature up to 300 °C, but again decreases towards higher temperatures, which complies with the above discussion. Thus, the O 1s component at BE = 530.8 eV is attributed to adsorbed oxygen species, which gradually penetrate the NML along internal interfaces and defect channels during heating in air. The weak O 1s peak at BE = 528.0 eV, which is only observed at the highest annealing temperature of 420 °C, is attributed to the formation of chemisorbed O_{chem} species at the NML surface and at internal interfaces.\textsuperscript{39,56}

Notably the O 1s and Al 2p chemical species found in the inner part of the Ag/AlN sample are preserved throughout the entire NML structure (i.e. up to the sapphire substrate; not shown). This suggests that, even at relatively low temperatures (i.e. 200 °C) O_{ads} species are able to penetrate the entire NML through defect channels and along internal interfaces.

Summarizing, the XPS chemical state analysis of Ag/AlN NMLs after air annealing up to 420 °C indicates that the inward diffusion of oxygen species along defect channels inside the NML becomes thermally activated at temperatures as low as 200 °C. The inwardly diffusing O atoms preferentially react with the AlN barriers to form amorphous Al_{2}O_{3}, but also chemically interact with the confined Ag layers. The adsorption and dilution of (electronegative) atomic impurities (i.e. O, Cl) are known to affect vacancy formation energy in Ag,\textsuperscript{59-61} enhancing its surface self-diffusion\textsuperscript{62,63} to an extent which is not found under vacuum.\textsuperscript{64} Recent DFT calculations indicate that the Ag vacancy formation energy can be reduced by an order of 3 if oxygen is adsorbed or diluted in Ag.\textsuperscript{65} Evidently, this effect should be very pronounced for Ag nanolayers with thicknesses of only 5 nm, since a majority of Ag atoms will be associated with the interfaces between the partially oxidized AlN barrier layers and the confined Ag nanolayers. It is therefore proposed that the enhanced mobility of Ag upon annealing in ambient atmospheres (as compared to annealing in vacuum) originates from the reduction of the activation energies for vacancy formation in the confined Ag nanolayers (as induced by the interaction with adsorbed O), which enhances their atomic mobility. Therefore, an O-rich atmosphere during the thermal processing of the Ag/AlN NML brazing fillers is of key importance in promoting extensive Ag migration for low-temperature joining.

4. Conclusions

This work presents a comprehensive investigation of the microstructural evolution of [Ag/AlN]_{nm} NML coatings on α-Al_{2}O_{3}(1̅1̅02) substrates upon heating under vacuum or in air by electron microscopy (SEM and TEM), X-ray spectroscopy (XPS) and diffraction (\textit{in situ} and \textit{ex situ} XRD).

Fast annealing in air up to 420 °C induces extensive migration of Ag from the interior of the NML to the surface at temperatures as low as 200 °C, which results in the formation of a high density of spherical Ag particles at the NML surface. In the temperature range of 200 °C < T < 280 °C, large compressive stresses are accumulated in the confined Ag layers (due to the thermal expansion mismatch with the substrate). However, these stresses become fully relaxed upon further heating in the range 280 °C < T < 400 °C, in accordance with the observed migration of the confined Ag to the NML surface. The Ag particles on the surface can coarsen at a much higher rate as compared to the (still) confined Ag nano-grains and also exhibit a nearly stress-free state during further heating and subsequent cooling.

Strikingly, the outward migration of Ag is much less pronounced for an identical heat treatment under vacuum, as well as for much thicker sandwiched Ag films. As evidenced by the XPS analysis of the annealed Ag/AlN NML, oxygen penetrates the pristine Ag/AlN NML along grain boundaries, internal interfaces and growth defects at temperatures as low as 250 °C. This inwardly diffusing O preferentially reacts with the AlN barrier layers to form an amorphous Al_{2}O_{3} phase, but concurrently also interacts with the confined Ag nanolayers. The chemical interaction between inwardly diffusing O and Ag reduces the activation energy for vacancy formation in the Ag nanolayers and thereby enhances the mobility of Ag atoms at low temperatures.

It is concluded that the reduction of the sum of grain-boundary and interface energies provides the main driving force for Ag outward migration and grain coarsening up to 420 °C; compressive stress relaxation provides an additional driving force contribution over a limited T-range of 280 °C < T < 400 °C. Evidently, an O-rich atmosphere during thermal processing is of key importance to enhance the kinetics of the Ag migration process at low temperatures, which could be exploited for novel low-temperature joining applications.

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